



Single Event Upset Error Rate Predictions using MRED

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Motivation



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- **Single event upset test data does not always conform to the standard rectangular parallelepiped model (CREME96)**
 - Secondary particle generation from high energy heavy ions.
 - Single particle-multiple node effects.
- **MRED provides an alternative solution to CREME96 for performing error rate predictions**
 - Includes nuclear physics and tracks secondary particles.
 - TCAD interface for solid model creation, materials specification, and event capture.
 - Allows for the tracking of charge generation in multiple sensitive regions.
 - Flexible interface for real-time spice analysis of circuit response.
- **MRED has been used for heavy ion error rate predictions in**
 - Hardened SRAM
 - DICE latches
 - DICE Flip Flops

Nuclear Reactions and SEU Response

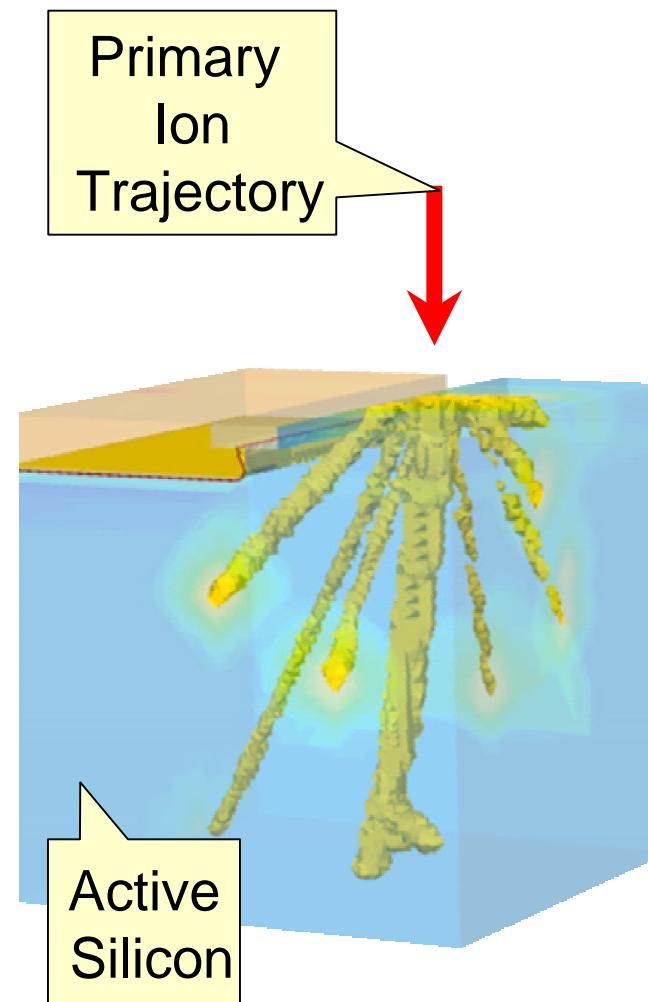


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- One of the original applications of MRED was understanding the SEU response of a 0.25 μm hardened SRAM.
- Identified nuclear reactions as a contributor to the measured SEU cross section curve.
- Inclusion of nuclear reactions was vital to determining the proper in-flight SER.
- K.M. Warren, et al., “The Contribution of Nuclear Reactions to Heavy Ion Single Event Upset Cross-section Measurements in a High-density SEU Hardened SRAM,” IEEE Trans. Nuc. Sci. Vol 52, Dec. 2005 pp 2125 – 2131.
- R.A. Reed, et al., “Implications of Nuclear Reactions for Single Event Effects Test Methods and Analysis”, IEEE Trans. Nuc. Sci., Vol 53, Dec 2006. Pp 3356-3362.
- D.R. Ball, et al., “Simulating Nuclear Events in a TCAD Model of a High-Density SEU Hardened SRAM Technology,” IEEE Trans. Nuc. Sci., Vol 53, Aug 2006. Pp 1794-1798.
- C.L. Howe, et al., “Role of heavy-ion nuclear reactions in determining on-orbit single event error rates,” IEEE Trans. Nuc. Sci., Vol 52, Dec 2005, pp 2182-2188.
- R.A. Reed, et al., “Impact of Ion Energy and Species on Single Event Effects Analysis,” IEEE Trans. Nuc. Sci., in print.

Nuclear Reactions

- Nuclear reactions between high energy ions and high Z materials used in semiconductor manufacturing produce secondary particles
- May produce high-mass fragments
- Fragments can have higher LET than primary.
- Probability of a nuclear reaction is small, but can still dominate error rate for hardened technologies.



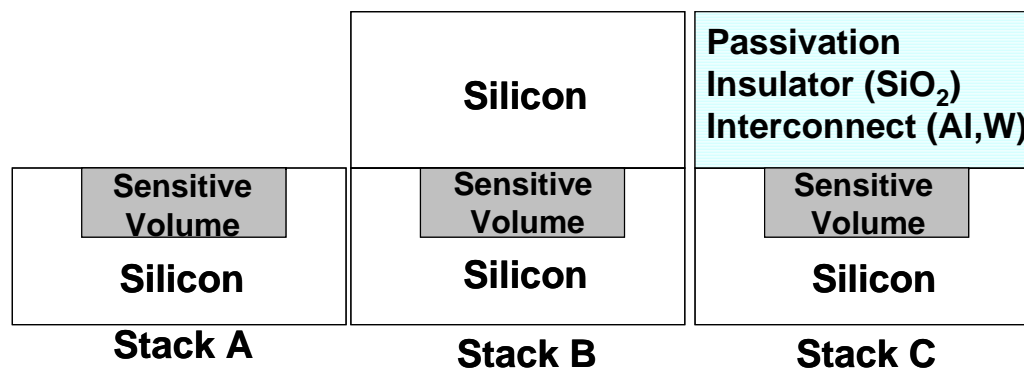
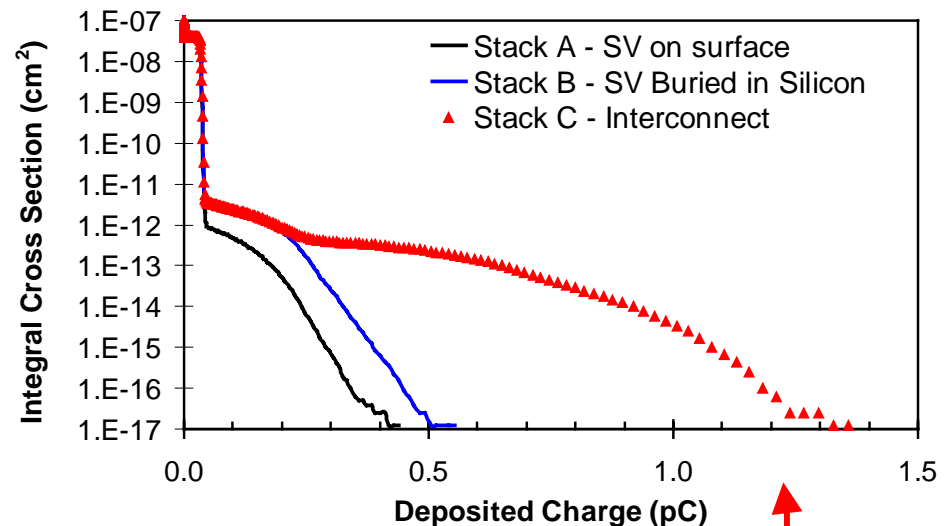
This event deposits significantly more energy than that by a single primary ion.

Nuclear Reactions

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- Quantitatively, what is the effect of high Z materials?
- The addition of tungsten pushes peak charge deposition over 30x primary LET

523 MeV Neon

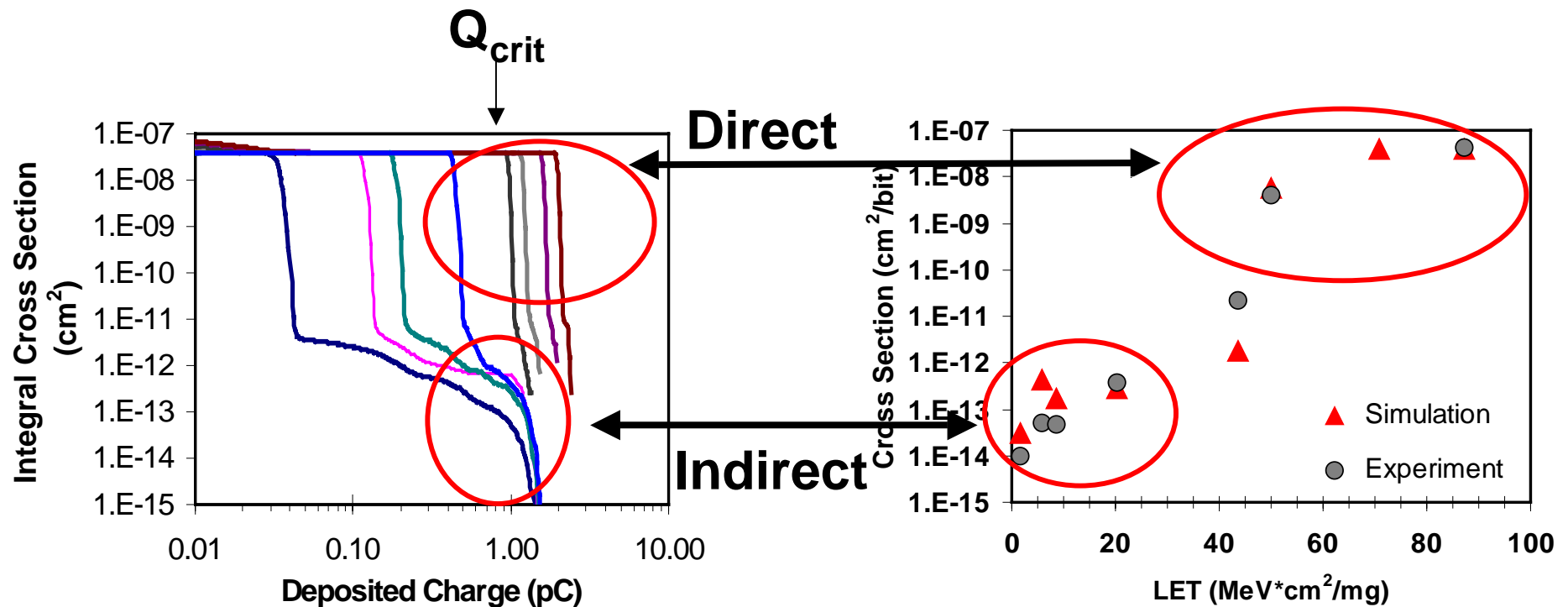


Tungsten layer exacerbates effect

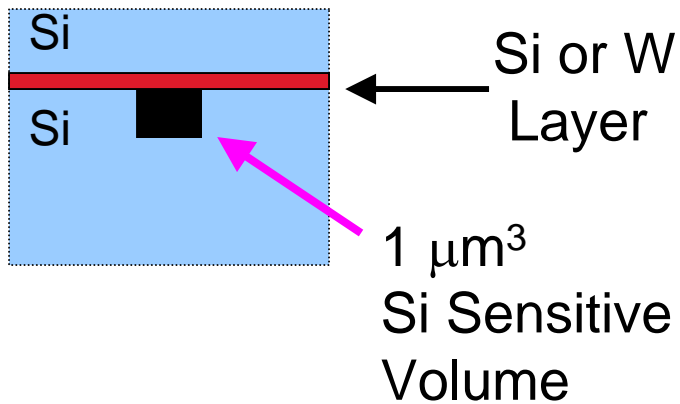
Nuclear Reactions

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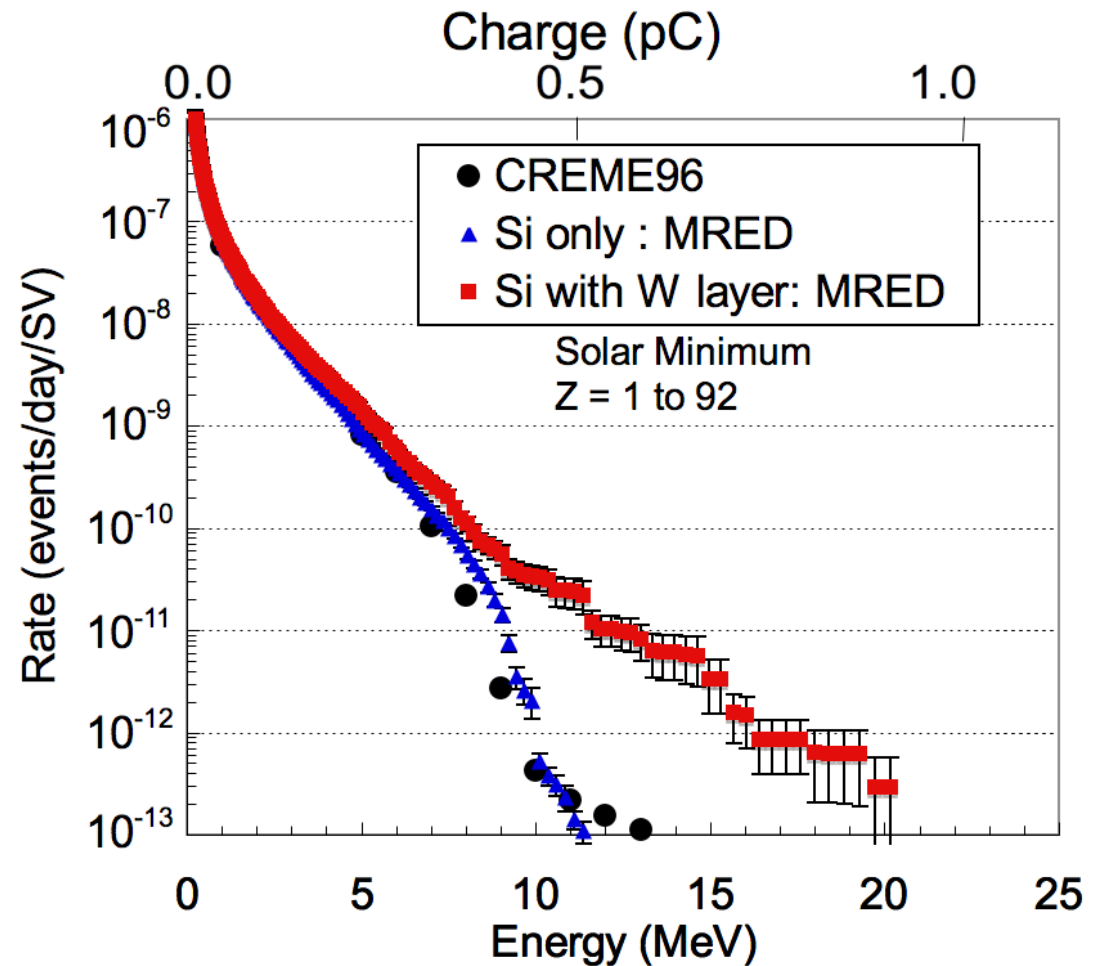
- Calorimetry on the sensitive volume (left figure) indicates two relevant regions
 - Direct Ionization – the generated charge is from ionization by the primary particle
 - Indirect Ionization – the generated charge is from the secondary product(s) of a nuclear reaction



Nuclear Reactions



The red squares are the event rates when a thin tungsten layer is placed near the sensitive volume.



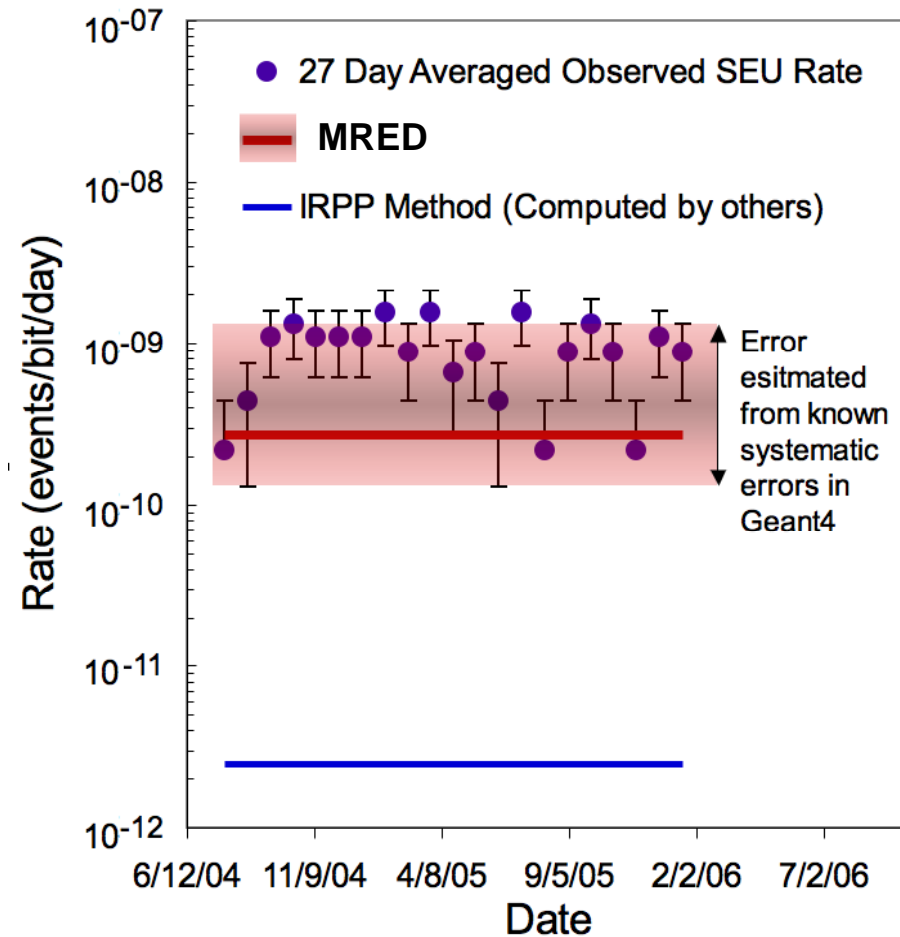
- **Conclusion: High Z materials in BEOL processing, such as tungsten, can increase the on-orbit SER**

Nuclear Reactions – on orbit SER



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- Modeling nuclear reactions *can* be vital to predicting the correct on-orbit error rate.
- Flight data on a hardened 4 Mbit SRAM support hypothesis.
- Direct ionization and IRPP method under-predict in flight SER by over 3 orders of magnitude.
- The inclusion of nuclear reactions and BEOL materials in the MRED model dramatically improves the fidelity of the rate prediction.
- Test and analysis must be performed to correctly identify when the higher fidelity models are needed.



**On-orbit flight data
4Mbit SRAM (BAE)**

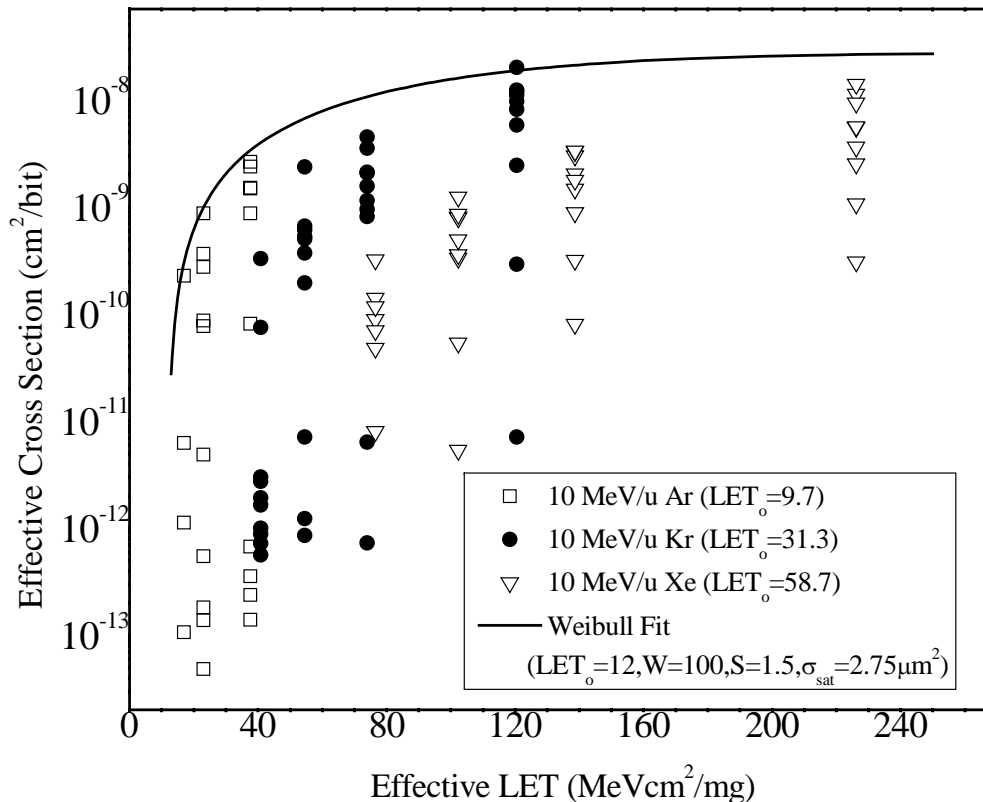
SEU Rate Prediction – 90 nm DICE Latch



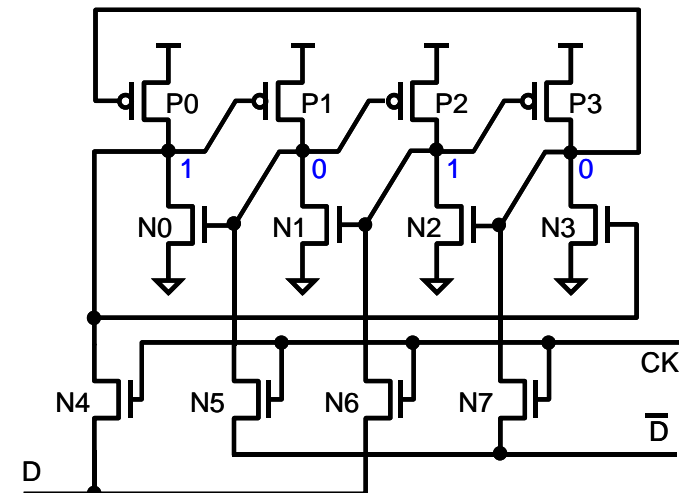
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- **Multiple node charge collection and/or charge generation processes dominate the SEU response of single node hardened circuitry**
- **Difficult or impossible to accurately model using RPP methods.**
- **Demonstrate the use of MRED for developing a SEU response model suitable for in-flight SEU rate predictions.**
- **K.M. Warren, et al., “Monte-Carlo Based On-Orbit Single Event Upset Rate Prediction in a Radiation Hardened by Design Latch,” IEEE Trans. Nuc. Sci., in print.**

DICE Latch – Multi-node processes (90nm)



Heavy ion data and circuit for a 90nm DICE latch

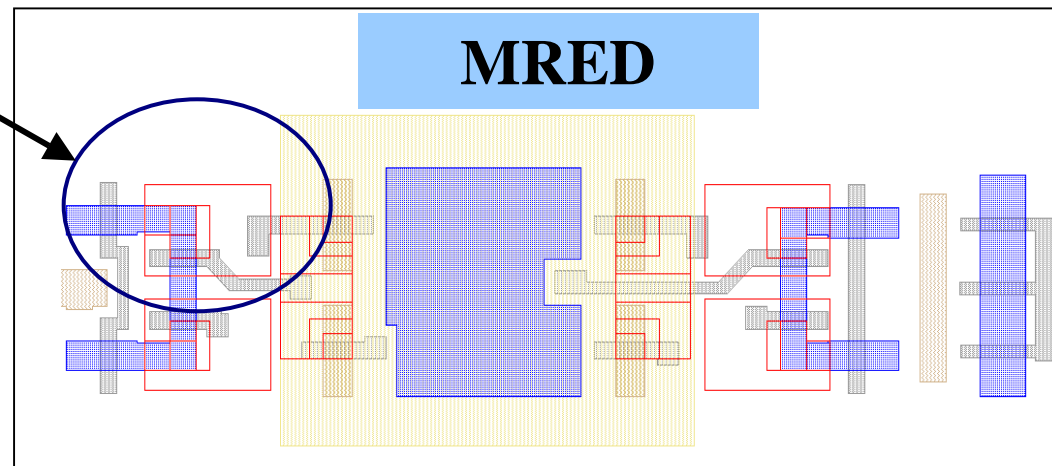


- In hardened circuits, heavy ion SEU test data may not fit the traditional RPP model used in CREME96 calculations.
- When two regions must be struck simultaneously, the the probability of an upset becomes one of coincidence between two regions.
- Identified by a cross section curve that is not well behaved in terms of effective cross section versus effective LET.
- The data above show an azimuthally dependent cross section and the cosine law is not applicable

DICE Latch (90nm) – MRED Implementation

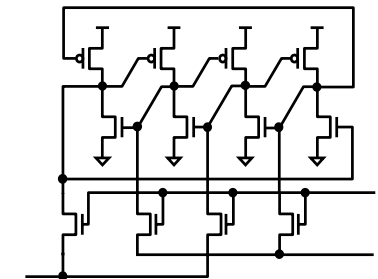
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Red Square
Denote Sensitive
Volumes



Test for Valid
Events

SPICE

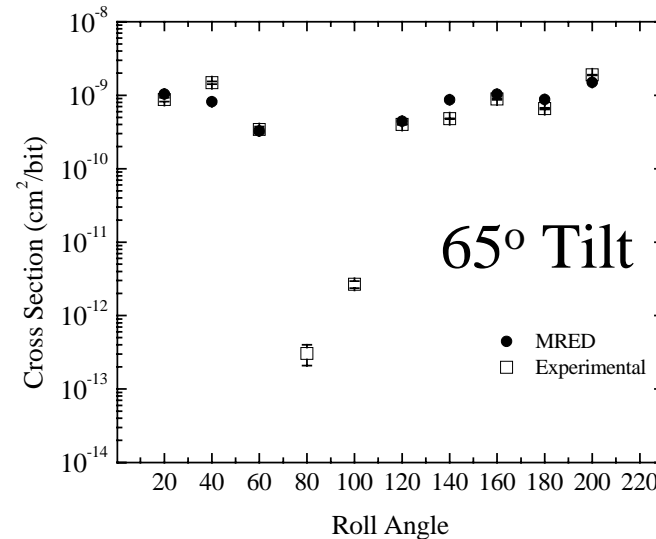
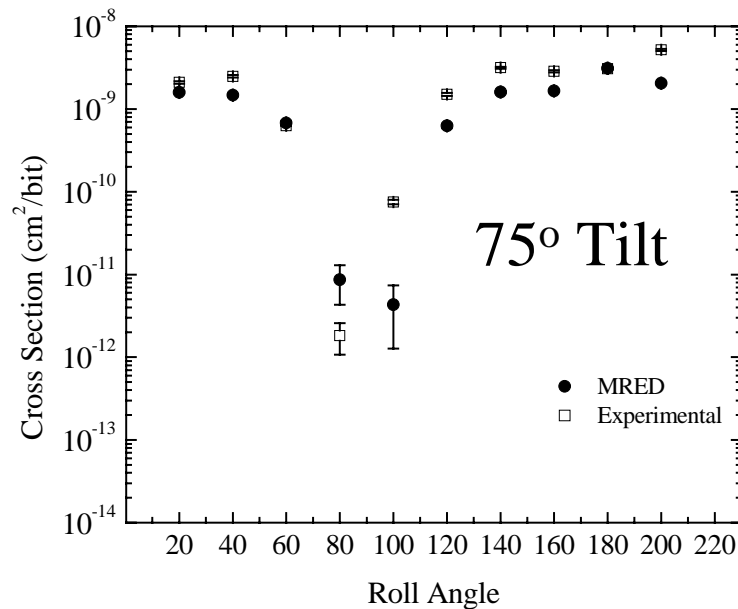


Identify
Sensitive
Tx Pairs

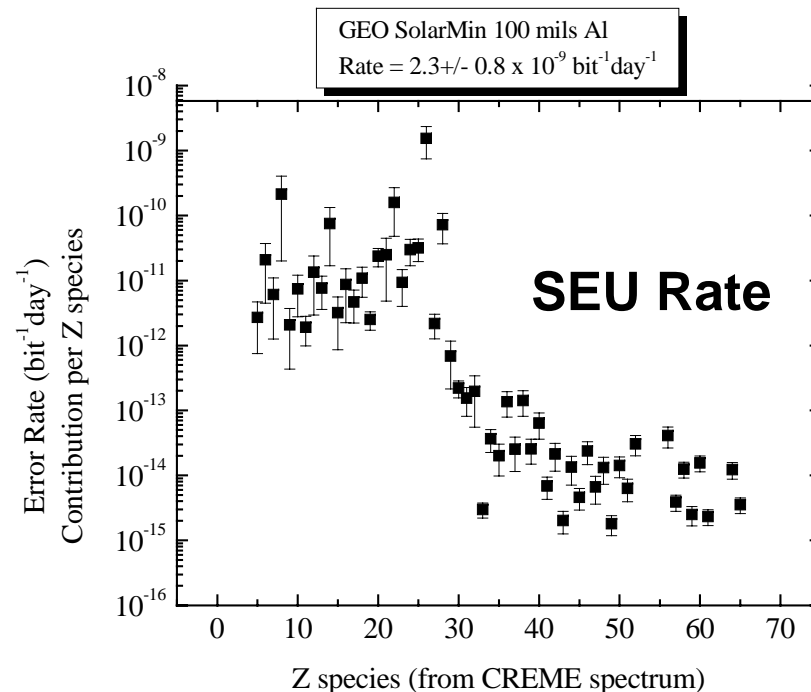
- This latch had 10 combinations of two-node events that would lead to an SEU.
- Calibrated volume sizes and placements based on test data, TCAD results, and engineering judgment.

Dice Latch (90nm) - Results

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- Using multiple volumes and coincidence testing with calibration resulted in a model that captured the SEU cross section as a function of LET, azimuth (roll), and tilt.
- Space environment fed into calibrated model for SEU rate calculation.



Dice Latch (65nm)



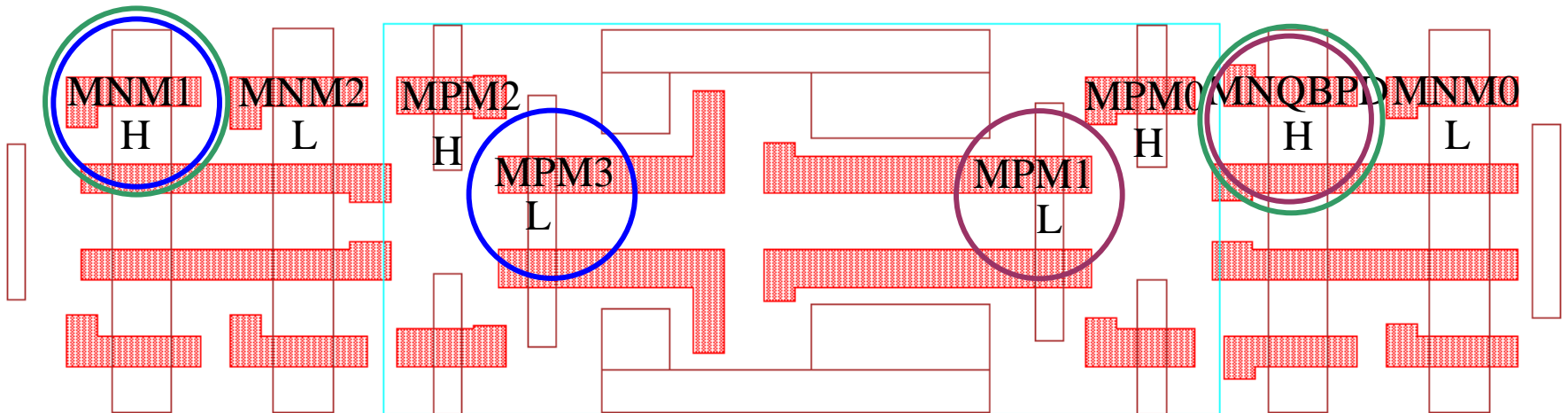
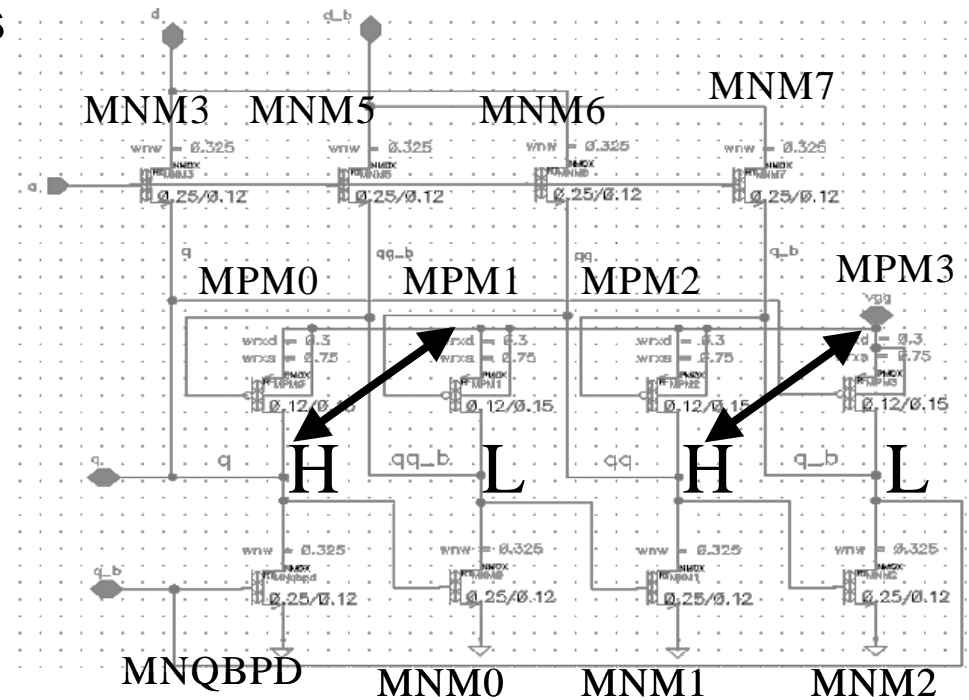
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- **A similar rate prediction was performed for the same DICE latch circuit in 65 nm.**
- **In this case, MRED was used to evaluate possible re-design ideas to improve SEU performance.**

Sensitive Pairs - Circuit in data high $q=1$

- The current sensitive node pairs dominate the cross sections

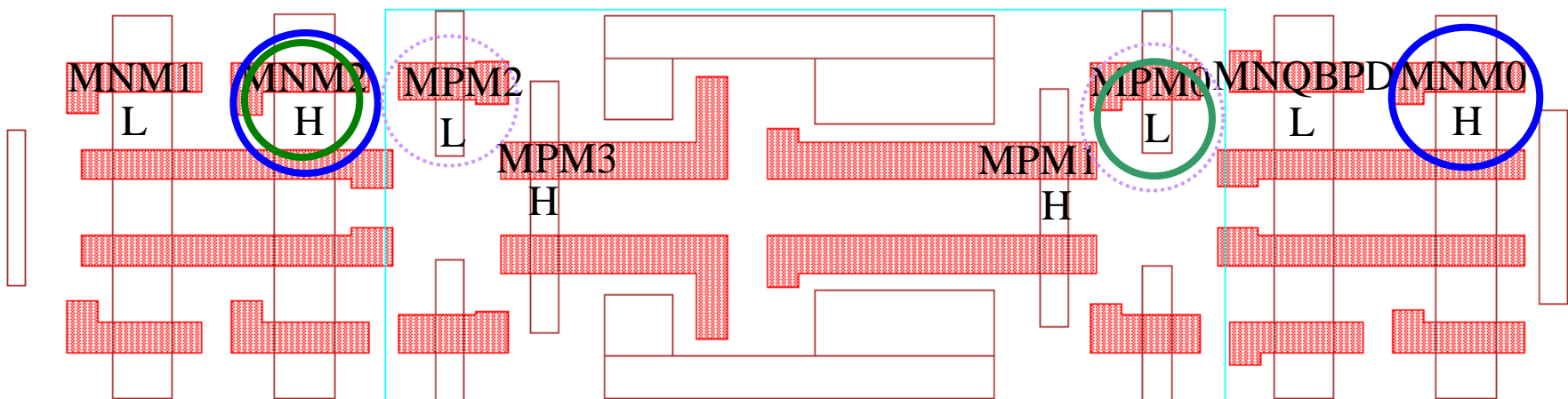
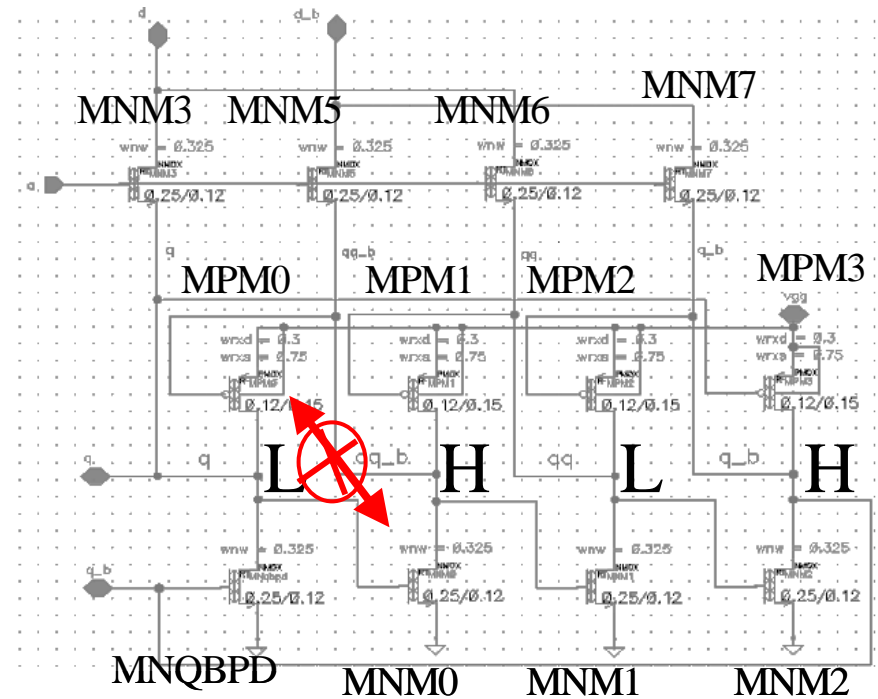
- Shallow tilt angles
 - ◆ MNM1-MPM3
 - ◆ MNQBPD-MPM1
- Steep tilt angles
 - ◆ MNM1-MNQBPD



Sensitive Pairs - Circuit in data low $q=0$

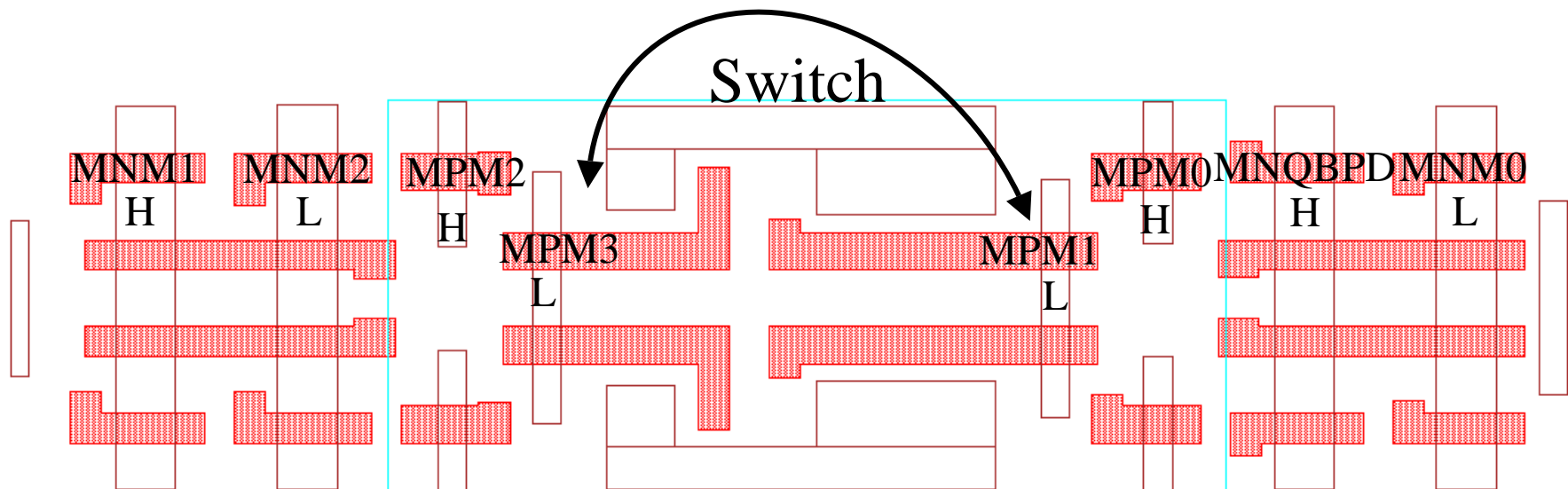
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- MNM2/MPM0, MNM2, MNM0 pairs are main error contributors.
- Much smaller experimental cross section for $q=0$.
- Note that there is not a sensitive N-P combination on the left side of the layout.



Re-design Idea!

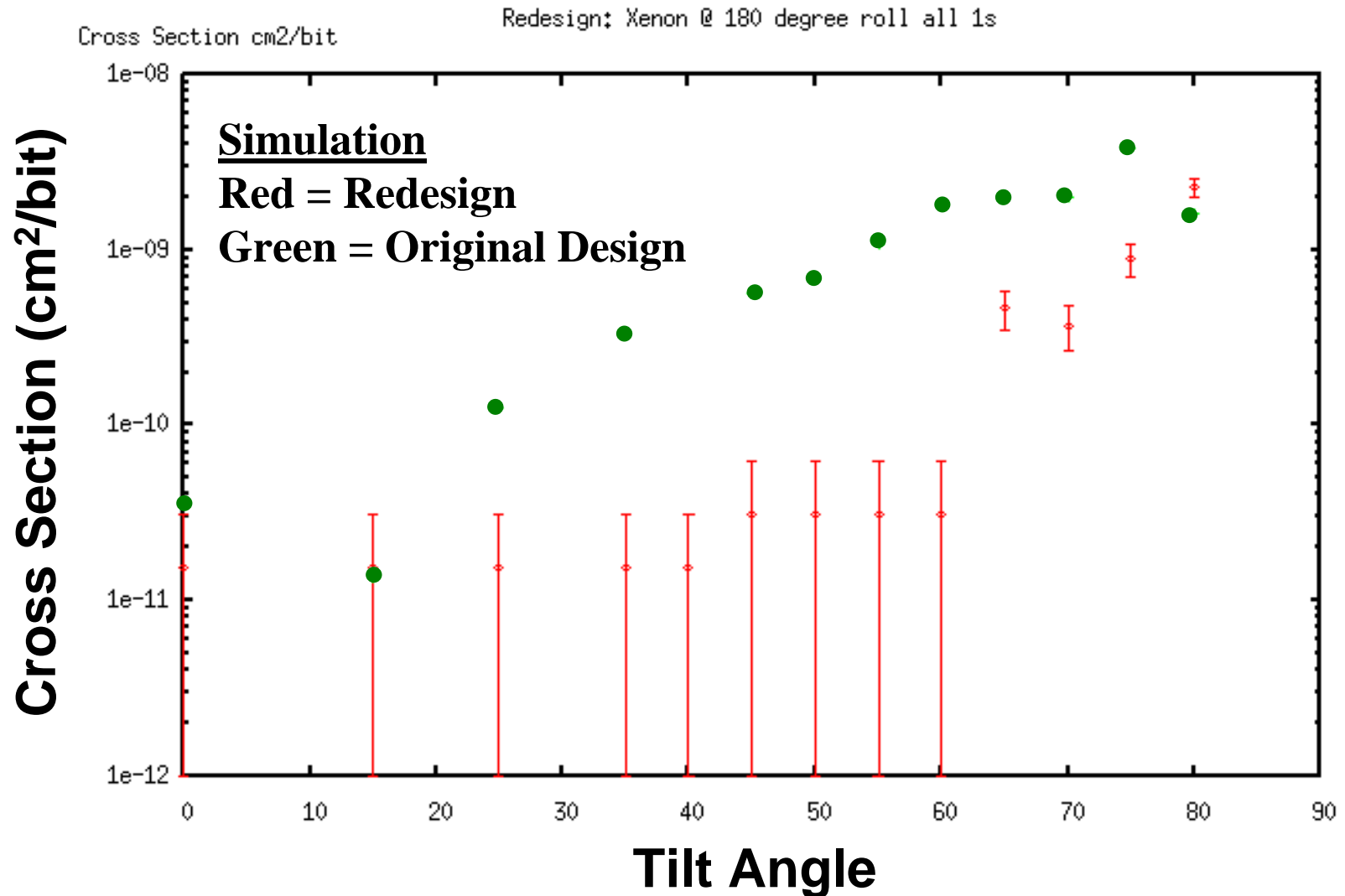
- It appears that in $q=0$, there are no adjacent sensitive pairs – every sensitive node pair is well separated. This does not appear to be true in $q=1$. How can we use this?
- We know that it is possible that MPM3/MNM1 and MPM1/MNMQBPD coupling can upset the circuit (not sure how much at this point)
- Switching the location of MPM3 and MPM1 might solve the problem! This would not require a change in silicon, only a change in interconnect (theoretically)
- In this condition, no previously identified sensitive node combinations would exist together on either side of the layout.



All 1's, Xenon over tilt



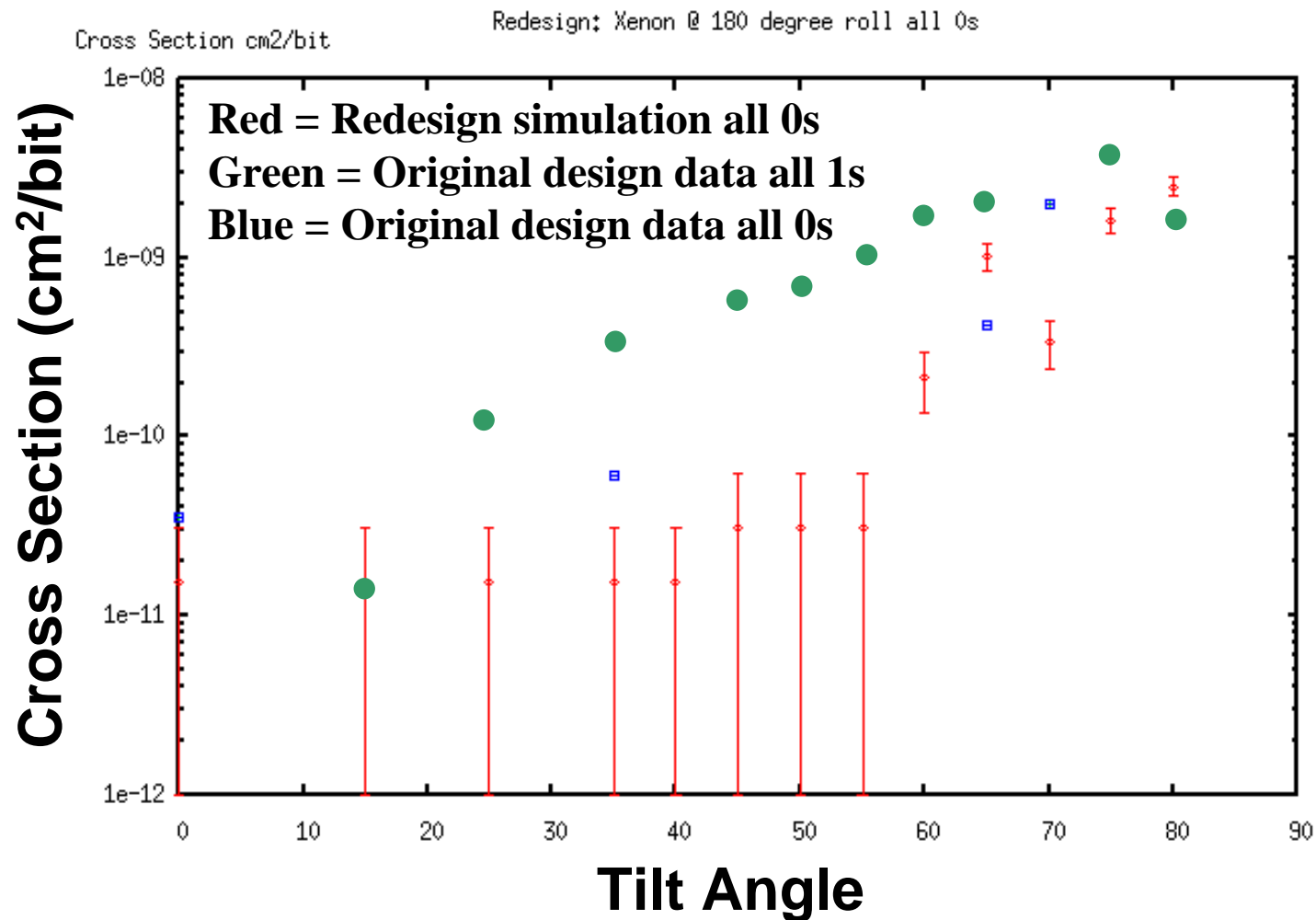
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- Moving sensitive pairs produces a reduction in SEU cross section.

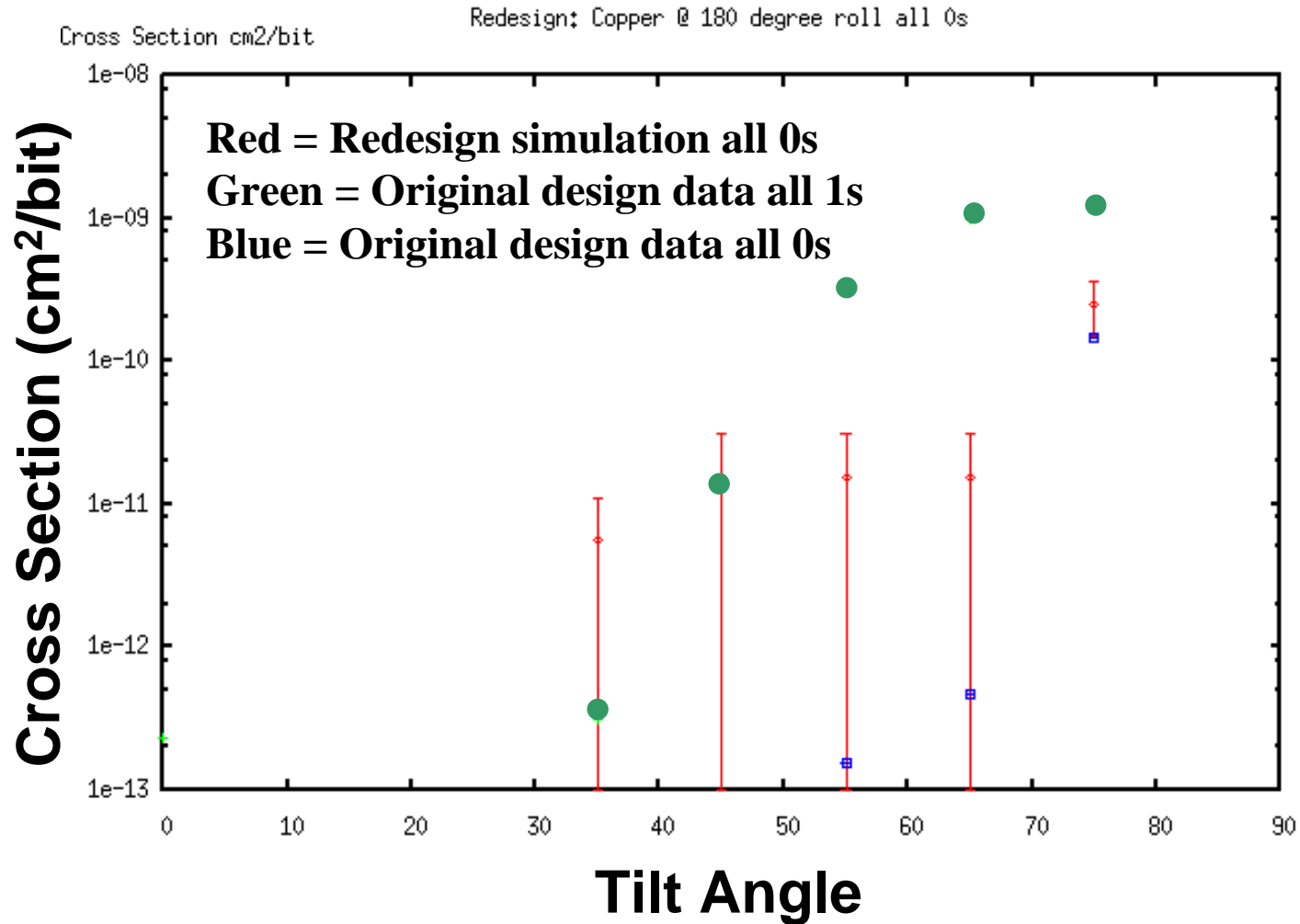
Xenon over tilt

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- Note that the all 1s and all 0s cases are now very similar. Fortunately, the prediction is that both 1s and 0s will have a low cross section.

Copper over tilt



- All 1's and all 0's data are now similar and have smaller cross sections.

Hardened Master Slave Flip Flop

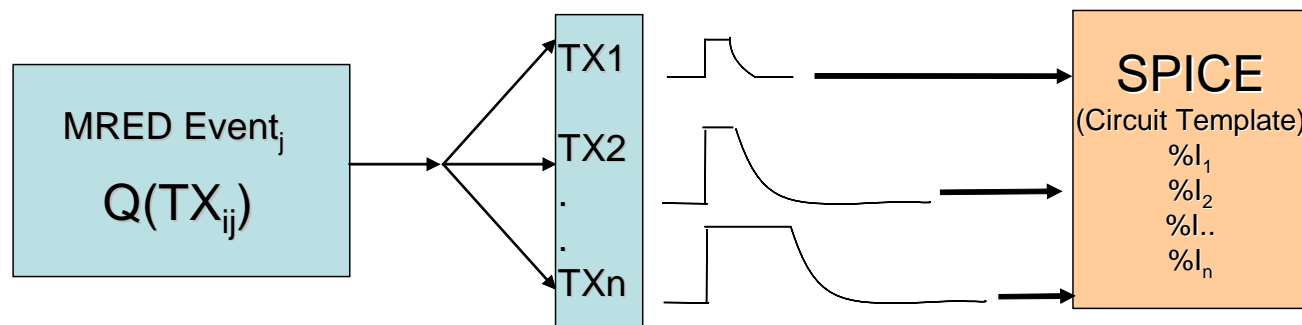
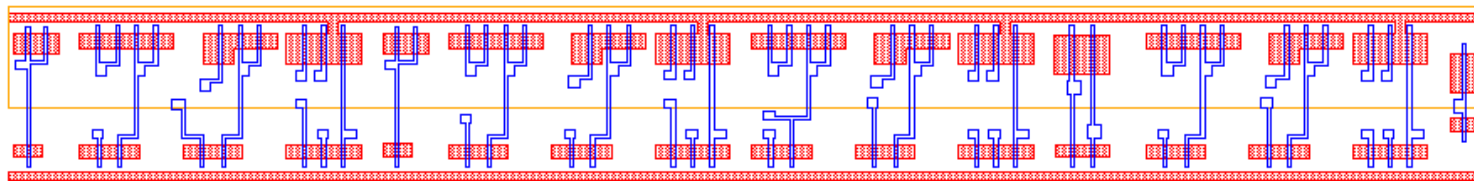


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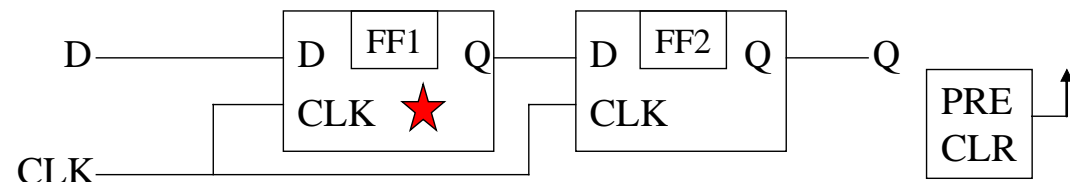
- **A rate prediction was performed for a master slave flip flop (90nm)**
- **Significant developments in MRED include the inclusion of Spice in the loop**
- **Avoid hand identification of sensitive nodes and sensitive node pairs**

Hardened Master Slave Flip Flop

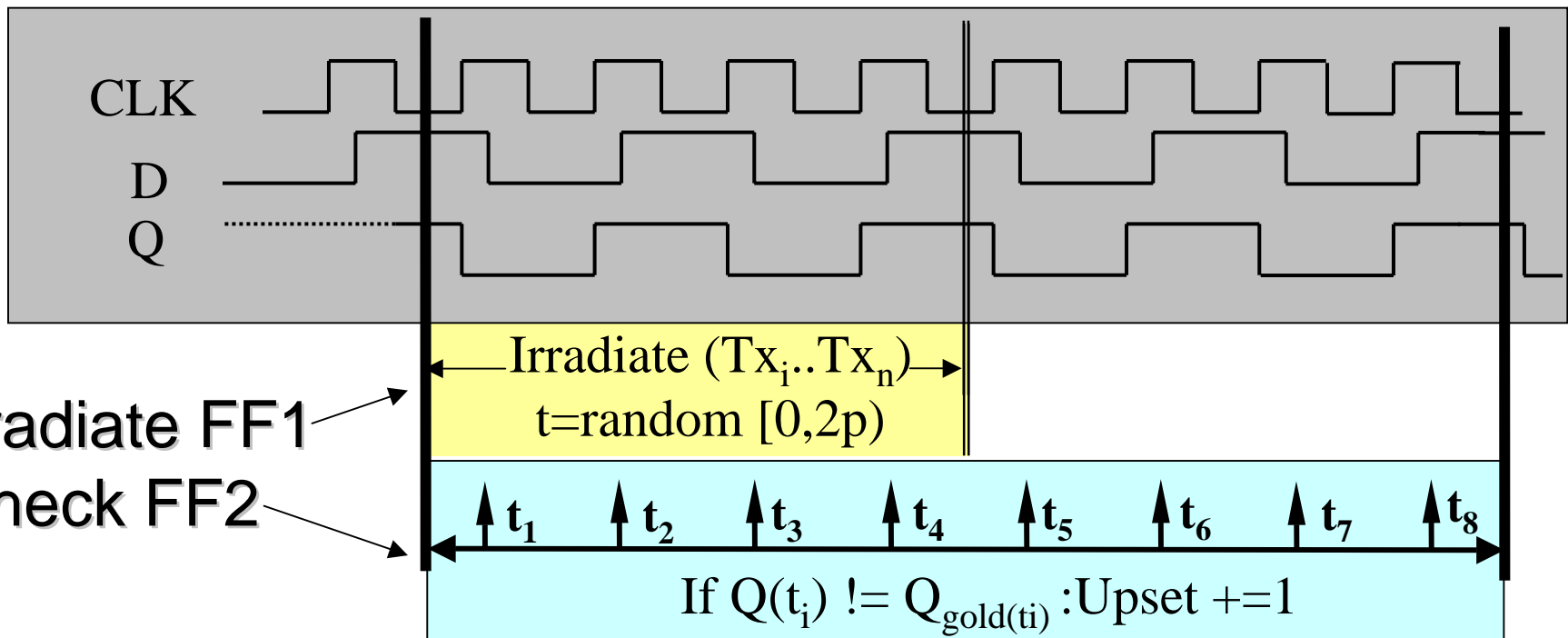
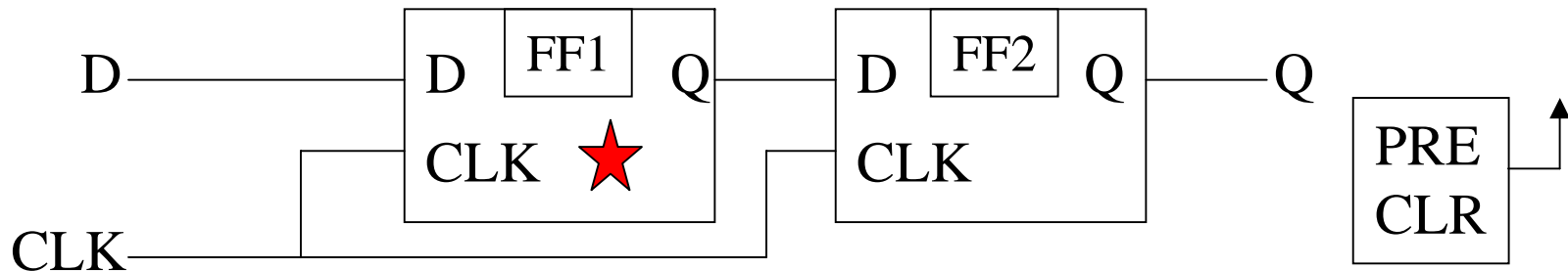
- Spice and MRED have been coupled during run-time to evaluate valid SEU conditions on an event by event basis.
- Very useful for large circuits such as the 60+ transistor DICE master-slave flip flop shown below.
- Avoids manually identifying sensitive node combinations and critical charges.



Irradiate FF1 at a random time and watch for an upset clocked out of FF2. This process was repeated over 100,000 times for the final simulation set.

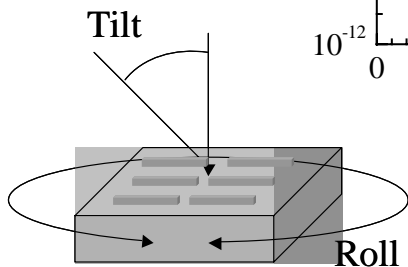
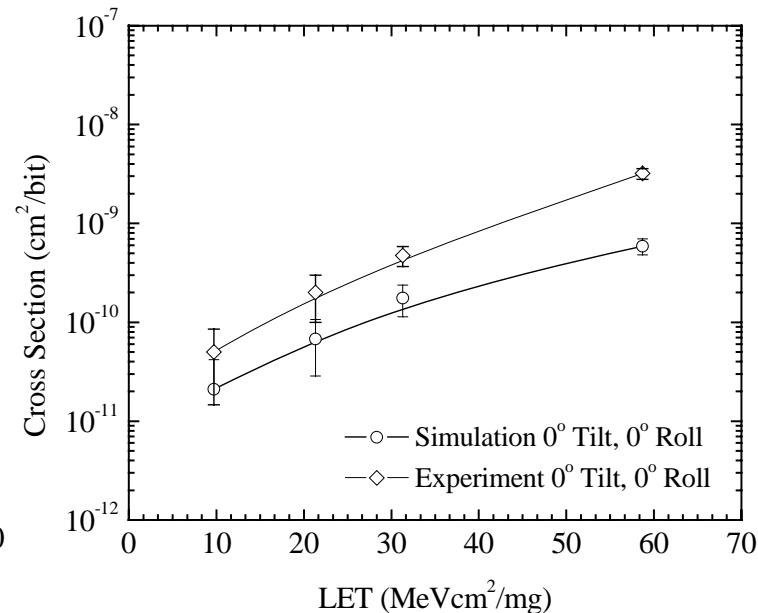
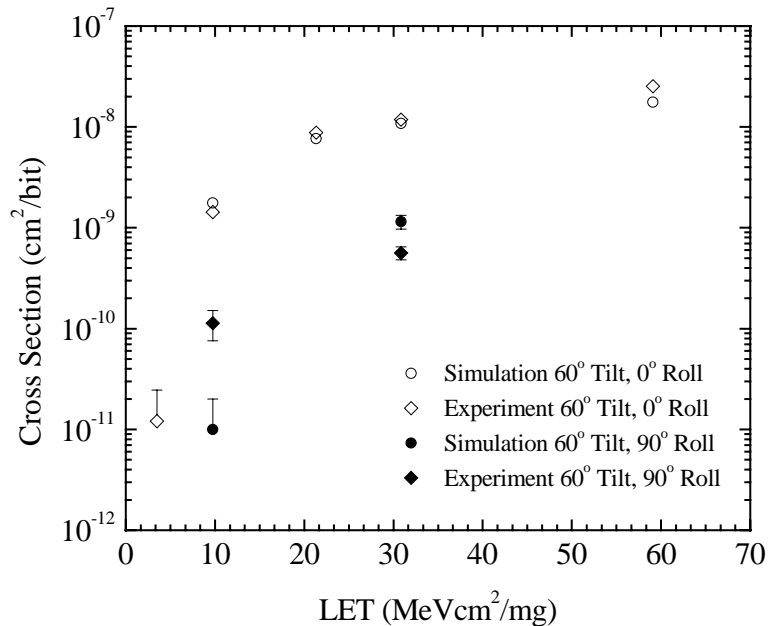


SPICE Timing and Flow



Irradiate FF1 at a random time and watch for an upset clocked out of FF2. This process was repeated over 100,000 times for the final simulation set.

Hardened Master Slave Flip Flop

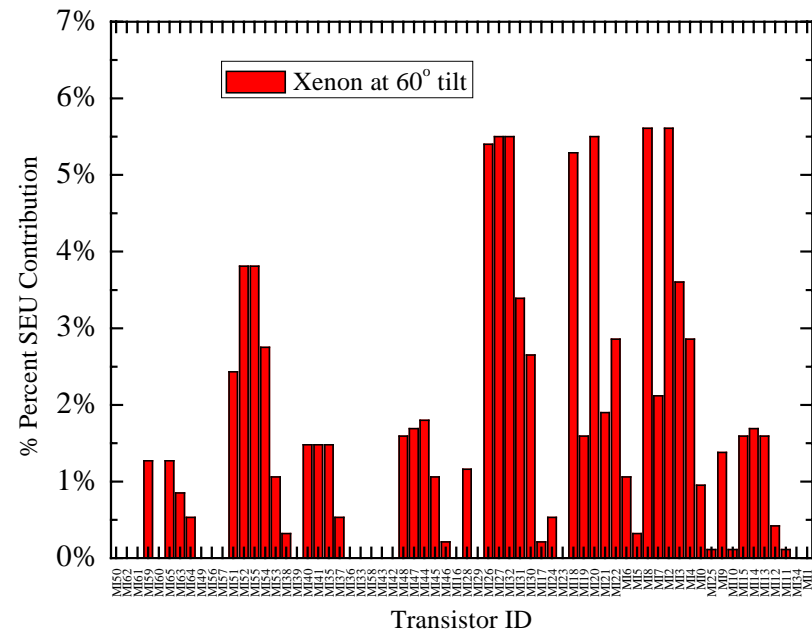


- The modeled SEU response is completely self contained.
- The model must still be calibrated to heavy ion data – sensitive volume dimensions and placement.
- The results can be used to directly identify weakness in the layout.

Hardened Master Slave Flip Flop

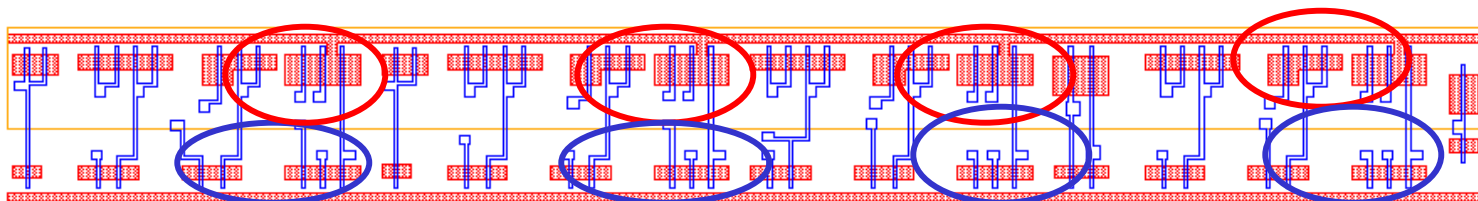
- All information related to each SEU event can be recorded.
- Identify sensitive regions in the layout.
- Perform qualitative assessment of new layouts (non-calibrated).

8 Distinct Clusters



PMOS

NMOS



Conclusions



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- **MRED provide a unique solution to determining on-orbit SER**
 - Nuclear reaction physics – high critical charge circuits, process dependence on SEU response.
 - Multi-node mechanisms – unique ability to place and track energy deposition in multiple sensitive volumes.
 - Exploring hardening solutions.
 - Spice coupling – provides a more automated means for identifying sensitive nodes and relating SEU response to layout.
- **Current MRED development focus with respect to error rate prediction**
 - Guidelines for sensitive volume parameters as a function of process/technology.
 - Methodologies for generating current pulses from sensitive volume charge generation in MRED-Spice simulations.
 - Interfacing MRED to higher level simulators (e.g. VHDL, SEU Tool).
 - Developing guidelines for heavy ion testing for the purpose of identifying when nuclear reactions are important in rate predictions.